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Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Active
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	400MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 105°C (TA)
Security Features	-
Package / Case	516-BBGA
Supplier Device Package	516-PBGA (27x27)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mpc8247czqtiea

1 Overview

This table shows the functionality supported by each SoC in the MPC8272 family.

Table 1. MPC8272 PowerQUICC II Family Functionality

Functionality	Package ¹	SoCs			
		MPC8272	MPC8248	MPC8271	MPC8247
516 PBGA					
Serial communications controllers (SCCs)	3	3	3	3	3
QUICC multi-channel controller (QMC)	Yes	Yes	Yes	Yes	Yes
Fast communication controllers (FCCs)	2	2	2	2	2
I-Cache (Kbyte)	16	16	16	16	16
D-Cache (Kbyte)	16	16	16	16	16
Ethernet (10/100)	2	2	2	2	2
UTOPIA II Ports	1	0	1	0	0
Multi-channel controllers (MCCs)	0	0	0	0	0
PCI bridge	Yes	Yes	Yes	Yes	Yes
Transmission convergence (TC) layer	—	—	—	—	—
Inverse multiplexing for ATM (IMA)	—	—	—	—	—
Universal serial bus (USB) 2.0 full/low rate	1	1	1	1	1
Security engine (SEC)	Yes	Yes	—	—	—

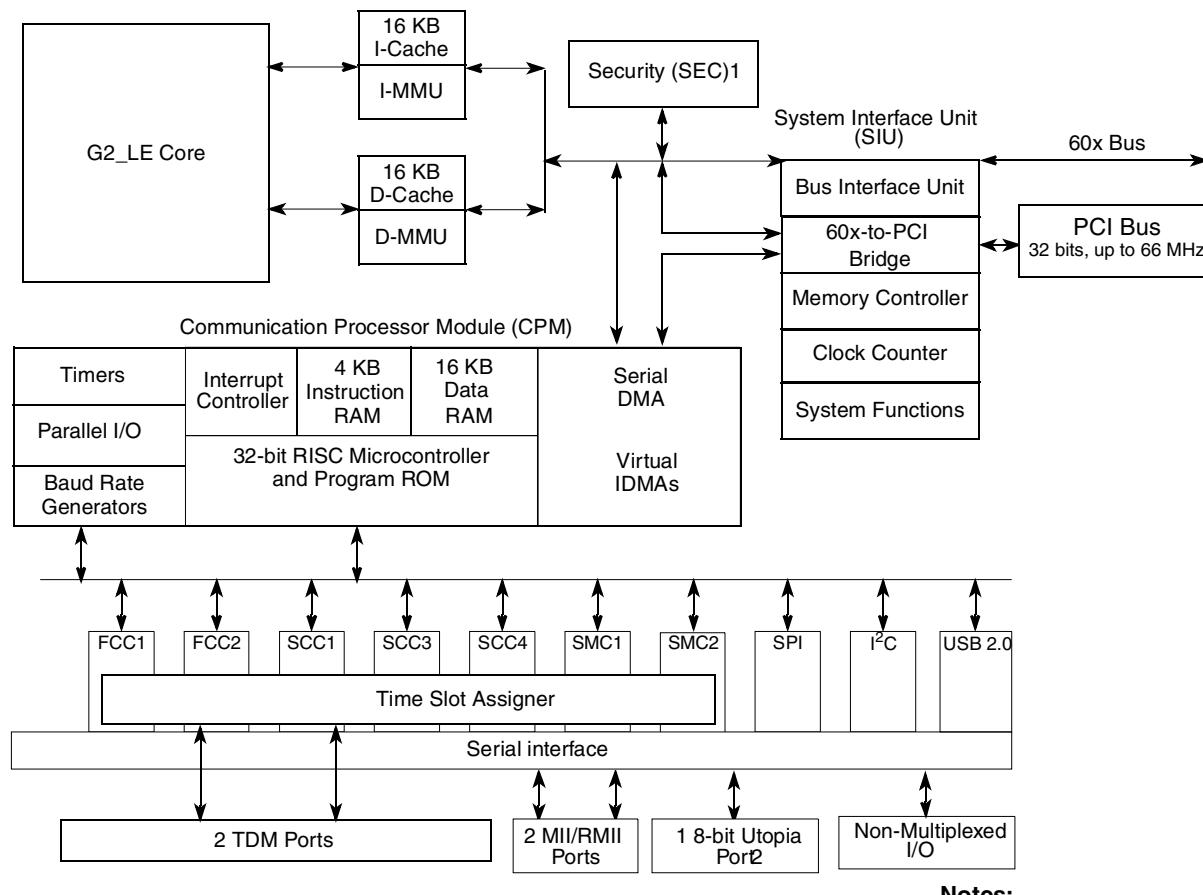
¹ See [Table 2](#).

Devices in the MPC8272 family are available in two packages—the VR or ZQ package—as shown in . For package ordering information, see [Section 10, “Ordering Information.”](#)

Table 2. MPC8272 PowerQUICC II Device Packages

Code (Package)	VR (516 PBGA—Lead free)	ZQ (516 PBGA—Lead spheres)
Device	MPC8272VR	MPC8272ZQ
	MPC8248VR	MPC8248ZQ
	MPC8271VR	MPC8271ZQ
	MPC8247VR	MPC8247ZQ

This figure shows the block diagram of the SoC.



Notes:

- 1 MPC8272/8248 only
- 2 MPC8272/8271 only

Figure 1. SoC Block Diagram

1.1 Features

The major features of the SoC are as follows:

- Dual-issue integer (G2_LE) core
 - A core version of the MPC603e microprocessor
 - System core microprocessor supporting frequencies of 266–400 MHz
 - Separate 16 KB data and instruction caches:
 - Four-way set associative
 - Physically addressed
 - LRU replacement algorithm
 - Power Architecture®-compliant memory management unit (MMU)
 - Common on-chip processor (COP) test interface
 - Supports bus snooping for cache coherency

- Floating-point unit (FPU) supports floating-point arithmetic
- Support for cache locking
- Low-power consumption
- Separate power supply for internal logic (1.5 V) and for I/O (3.3 V)
- Separate PLLs for G2_LE core and for the communications processor module (CPM)
 - G2_LE core and CPM can run at different frequencies for power/performance optimization
 - Internal core/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 4.5:1, 5:1, 5.5:1, 6:1, 7:1, 8:1
 - Internal CPM/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1, 8:1 ratios
- 64-bit data and 32-bit address 60x bus
 - Bus supports multiple master designs—up to two external masters
 - Supports single transfers and burst transfers
 - 64-, 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
- 60x-to-PCI bridge
 - Programmable host bridge and agent
 - 32-bit data bus, 66 MHz, 3.3 V
 - Synchronous and asynchronous 60x and PCI clock modes
 - All internal address space available to external PCI host
 - DMA for memory block transfers
 - PCI-to-60x address remapping
- System interface unit (SIU)
 - Clock synthesizer
 - Reset controller
 - Real-time clock (RTC) register
 - Periodic interrupt timer
 - Hardware bus monitor and software watchdog timer
 - IEEE 1149.1 JTAG test access port
- Eight bank memory controller
 - Glueless interface to SRAM, page mode SDRAM, DRAM, EPROM, Flash, and other user-definable peripherals
 - Byte write enables
 - 32-bit address decodes with programmable bank size
 - Three user-programmable machines, general-purpose chip-select machine, and page mode pipeline SDRAM machine
 - Byte selects for 64-bit bus width (60x)
 - Dedicated interface logic for SDRAM
- Disable CPU mode

Table 5. DC Electrical Characteristics¹ (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 5.3\text{mA}$ <u>CS[0-5]</u> <u>CS6/BCTL1/SMI</u> <u>CS7/TLBSYNC</u> <u>BADDR27/ IRQ1</u> <u>BADDR28/ IRQ2</u> <u>ALE/ IRQ4</u> <u>BCTL0</u> <u>PWE[0-7]/PSDDQM[0-7]/PBS[0-7]</u> <u>PSDA10/PGPL0</u> <u>PSDWE/PGPL1</u> <u>POE/PSDRAS/PGPL2</u> <u>PSDCAS/PGPL3</u> <u>PGTA/PUPMWAIT/PGPL4</u> <u>PSDAMUX/PGPL5</u> <u>PCI_CFG0 (PCI_HOST_EN)</u> <u>PCI_CFG1 (PCI_ARB_EN)</u> <u>PCI_CFG2 (DLL_ENABLE)</u> <u>MODCK1/RSRV/TC(0)/BNKSEL(0)</u> <u>MODCK2/CSE0/TC(1)/BNKSEL(1)</u> <u>MODCK3CSE1/TC(2)/BNKSEL(2)</u> $I_{OL} = 3.2\text{mA}$ <u>PCI_PAR</u> <u>PCI_FRAME</u> <u>PCI_TRDY</u> <u>PCI_IRDY</u> <u>PCI_STOP</u> <u>PCI_DEVSEL</u> <u>PCI_IDSEL</u> <u>PCI_PERR</u> <u>PCI_SERR</u> <u>PCI_REQ0</u> <u>PCI_REQ1/ CPI_HS_ES</u> <u>PCI_GNT0</u> <u>PCI_GNT1/ CPI_HS_LES</u> <u>PCI_GNT2/ CPI_HS_ENUM</u> <u>PCI_RST</u> <u>PCI_INTA</u> <u>PCI_REQ2</u> <u>DLLOUT</u> <u>PCI_AD(0-31)</u> <u>PCI_C(0-3)/BE(0-3)</u> <u>PA[8-31]</u> <u>PB[18-31]</u> <u>PC[0-1,4-29]</u> <u>PD[7-25, 29-31]</u> <u>TDO</u>	V_{OL}	—	0.4	V

¹ The default configuration of the CPM pins (PA[8-31], PB[18-31], PC[0-1,4-29], PD[7-25, 29-31]) is input. To prevent excessive DC current, it is recommended either to pull unused pins to GND or VDDH, or to configure them as outputs.

² TCK, TRST and PORESET have min VIH = 2.5V.

³ V_{IL} for IIC interface does not match IIC standard, but does meet IIC standard for V_{OL} and should not cause any compatibility issue.

⁴ The leakage current is measured for nominal VDDH, VCCSYN, and VDD.

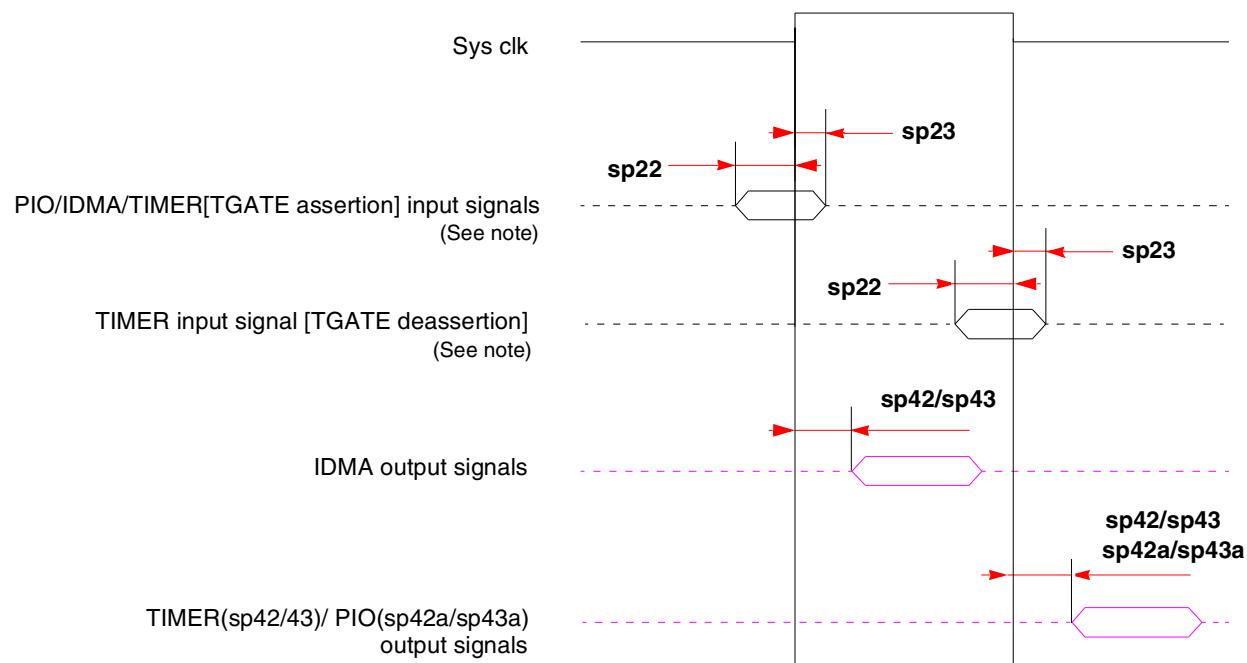
DC Electrical Characteristics

⁵ MPC8272 and MPC8271 only.

Table 6.

Characteristic	Symbol	Min	Max	Unit
Input high voltage—all inputs except TCK, TRST and PORESET ¹	V _{IH}	2.0	3.465	V
Input low voltage	V _{IL}	GND	0.8	V
CLKIN input high voltage	V _{IHC}	2.4	3.465	V
CLKIN input low voltage	V _{ILC}	GND	0.4	V
Input leakage current, V _{IN} = VDDH ²	I _{IN}	—	10	µA
Hi-Z (off state) leakage current, V _{IN} = VDDH ²	I _{OZ}	—	10	µA
Signal low input current, V _{IL} = 0.8 V ³	I _L	—	1	µA
Signal high input current, V _{IH} = 2.0 V	I _H	—	1	µA
Output high voltage, I _{OH} = -2 mA except UTOPIA mode, and open drain pins	V _{OH}	2.4	—	V
In UTOPIA mode ⁴ (UTOPIA pins only): I _{OH} = -8.0mA				
In UTOPIA mode ⁴ (UTOPIA pins only): I _{OL} = 8.0mA	V _{OL}	—	0.5	V
I _{OL} = 6.0mA BR BG ABB/IRQ2 TS A[0-31] TT[0-4] TBST TSIZE[0-3] AACK ARTRY DBG DBB/IRQ3 D[0-63] //EXT_BR3 //EXT_BG3 /TBEN/EXT_DBG3/CINT PSDVAL TA TEA GBL/IRQ1 CI/BADDR29/IRQ2 WT/BADDR30/IRQ3 BADDR31/IRQ5/CINT CPU_BR IRQ0/NMI_OUT /PCI_RST HRESET SRESET RSTCONF	V _{OL}	—	0.4	V

This figure shows PIO and timer signals.



Note: TGATE is asserted on the rising edge of the clock; it is deasserted on the falling edge.

Figure 8. PIO and Timer Signal Diagram

6.2 SIU AC Characteristics

This table lists SIU input characteristics.

NOTE: CLKIN Jitter and Duty Cycle

The CLKIN input to the SoC should not exceed $+/- 150$ psec of jitter (peak-to-peak). This represents total input jitter—the combination of short term (peak-to-peak) and long term (cumulative). The duty cycle of CLKIN should not exceed the ratio of 40:60.

NOTE: Spread Spectrum Clocking

Spread spectrum clocking is allowed with 1% input frequency down-spread at maximum 60 KHz modulation rate regardless of input frequency.

NOTE: PCI AC Timing

The SoC meets the timing requirements of *PCI Specification Revision 2.2*. See [Section 7, “Clock Configuration Modes,”](#) and “Note: Tval (Output Hold)” to determine if a specific clock configuration is compliant.

NOTE: Conditions

The following conditions must be met in order to operate the MPC8272 family devices with 133 MHz bus: single PowerQUICC II Bus mode must be used (no external master, BCR[EBM] = 0); data bus must be in Pipeline mode (BRx[DR] = 1); internal arbiter and memory controller must be used. For expected load of above 40 pF, it is recommended that data and address buses be configured to low ($25\ \Omega$) impedance (SIUMCR[HLBE0] = 1, SIUMCR[HLBE1] = 1).

Table 12. AC Characteristics for SIU Inputs¹

Spec Number		Characteristic	Value (ns)							
			Setup				Hold			
Setup	Hold		66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp11	sp10	AACK/T _A /T _S /DBG/BG/BR/ARTRY/T _E A	6	5	3.5	N/A	0.5	0.5	0.5	N/A
sp12	sp10	Data bus in normal mode	5	4	3.5	N/A	0.5	0.5	0.5	N/A
sp13	sp10	Data bus in pipeline mode (without ECC and PARITY)	N/A	4	2.5	1.5	N/A	0.5	0.5	0.5
sp15	sp10	All other pins	5	4	3.5	N/A	0.5	0.5	0.5	N/A

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

This table lists SIU output characteristics.

Table 13. AC Characteristics for SIU Outputs¹

Spec Number		Characteristic	Value (ns)							
			Maximum Delay				Minimum Delay			
Max	Min		66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp31	sp30	P _{SDVAL} /T _E A/T _A	7	6	5.5	N/A	1	1	1	N/A
sp32	sp30	ADD/ADD_atr./BADDR/CI/GBL/WT	8	6.5	5.5	4.5 ²	1	1	1	1 ²
sp33	sp30	Data bus ³	6.5	6.5	5.5	4.5	0.8	0.8	0.8	1
sp34	sp30	Memory controller signals/ALE	6	5.5	5.5	4.5	1	1	1	1
sp35	sp30	All other signals	6	5.5	5.5	N/A	1	1	1	N/A

¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

² Value is for ADD only; other sp32/sp30 signals are not applicable.

³ To achieve 1 ns of hold time at 66.67/83.33/100 MHz, a minimum loading of 20 pF is required.

NOTE

Activating data pipelining (setting BRx[DR] in the memory controller) improves the AC timing.

This figure shows the interaction of several bus signals.

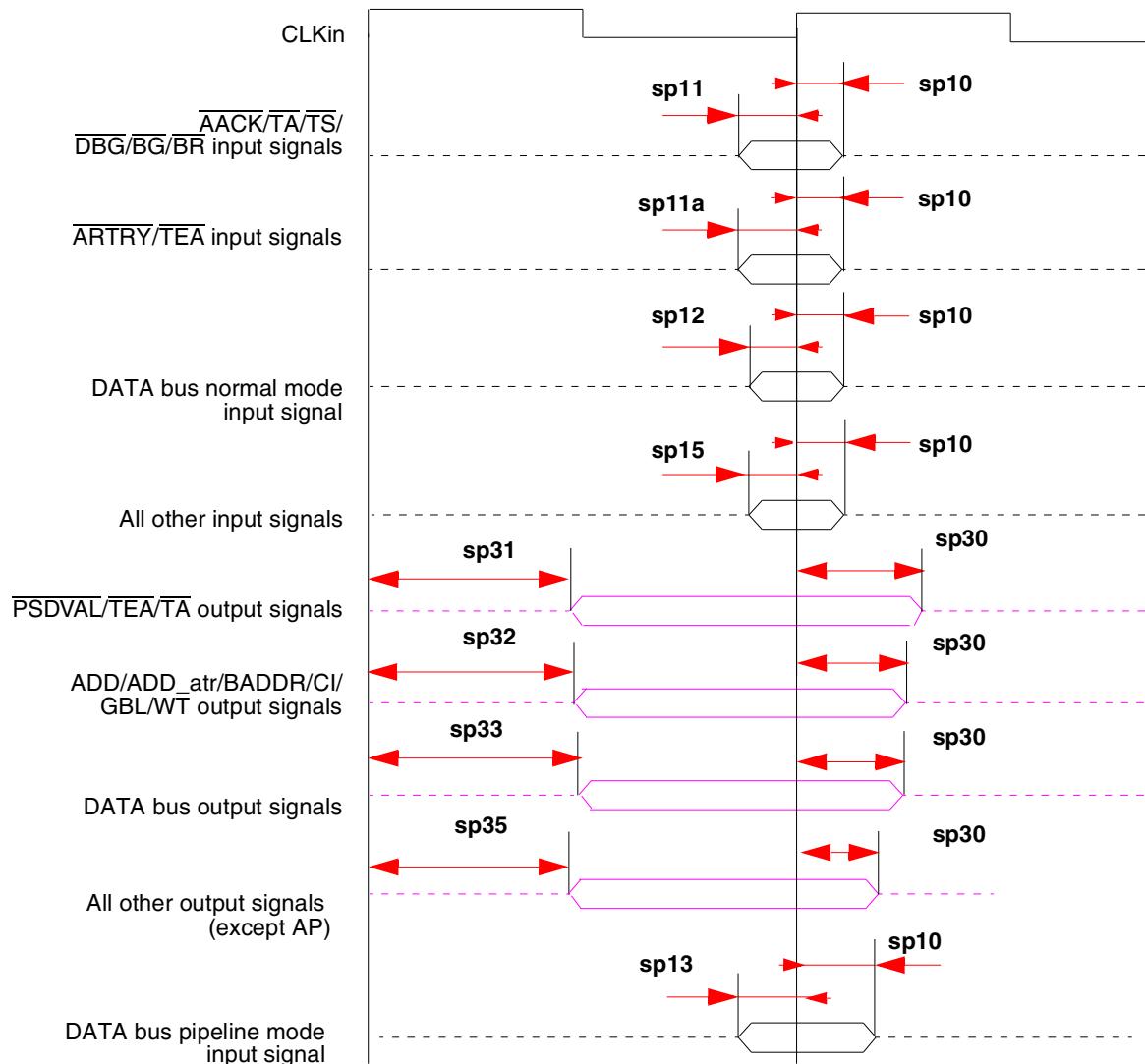


Figure 9. Bus Signals

This figure shows signal behavior in MEMC mode.

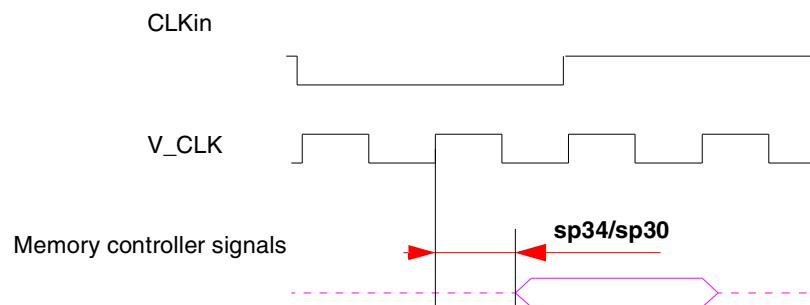


Figure 10. MEMC Mode Diagram

NOTE

Generally, all SoC bus and system output signals are driven from the rising edge of the input clock (CLKin). Memory controller signals, however, trigger on four points within a CLKin cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge, and T3 at the falling edge, of CLKin. However, the spacing of T2 and T4 depends on the PLL clock ratio selected, as shown in [Table 14](#).

Table 14. Tick Spacing for Memory Controller Signals

PLL Clock Ratio	Tick Spacing (T1 Occurs at the Rising Edge of CLKin)		
	T2	T3	T4
1:2, 1:3, 1:4, 1:5, 1:6	1/4 CLKin	1/2 CLKin	3/4 CLKin
1:2.5	3/10 CLKin	1/2 CLKin	8/10 CLKin
1:3.5	4/14 CLKin	1/2 CLKin	11/14 CLKin

This table is a representation of the information in [Table 14](#).

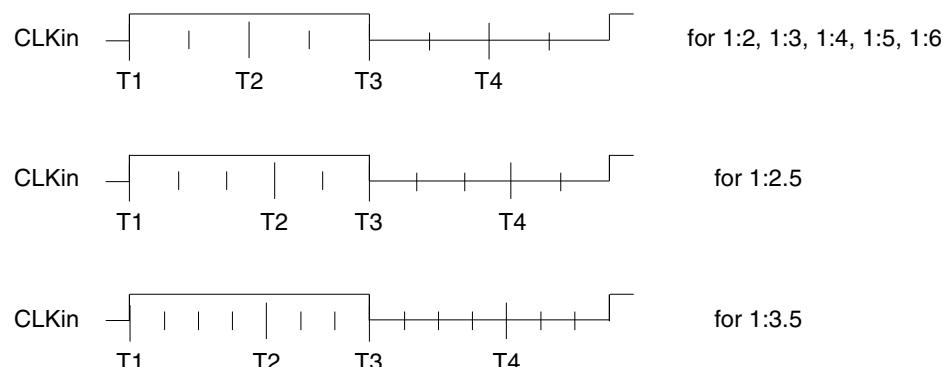


Figure 11. Internal Tick Spacing for Memory Controller Signals

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)^{1,2}

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]	Low	High								Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0000_011	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7
0000_100	60.0	80.0	2.5	150.0	200.0	4	240.0	320.0	3	50.0	66.7
0000_101	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_110	50.0	66.7	3.5	150.0	200.0	3.5	175.0	233.3	3	50.0	66.7
0000_111	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
Full Configuration Modes											
0001_000	50.0	66.7	3	150.0	200.0	5	250.0	333.3	3	50.0	66.7
0001_001	50.0	66.7	3	150.0	200.0	6	300.0	400.0	3	50.0	66.7
0001_010	50.0	66.7	3	150.0	200.0	7	350.0	466.6	3	50.0	66.7
0001_011	50.0	66.7	3	150.0	200.0	8	400.0	533.3	3	50.0	66.7
0010_000	50.0	66.7	4	200.0	266.6	5	250.0	333.3	4	50.0	66.7
0010_001	50.0	66.7	4	200.0	266.6	6	300.0	400.0	4	50.0	66.7
0010_010	50.0	66.7	4	200.0	266.6	7	350.0	466.6	4	50.0	66.7
0010_011	50.0	66.7	4	200.0	266.6	8	400.0	533.3	4	50.0	66.7
0010_100	75.0	100.0	4	300.0	400.0	5	375.0	500.0	6	50.0	66.7
0010_101	75.0	100.0	4	300.0	400.0	5.5	412.5	549.9	6	50.0	66.7
0010_110	75.0	100.0	4	300.0	400.0	6	450.0	599.9	6	50.0	66.7
0011_000	50.0	66.7	5	250.0	333.3	5	250.0	333.3	5	50.0	66.7
0011_001	50.0	66.7	5	250.0	333.3	6	300.0	400.0	5	50.0	66.7
0011_010	50.0	66.7	5	250.0	333.3	7	350.0	466.6	5	50.0	66.7
0011_011	50.0	66.7	5	250.0	333.3	8	400.0	533.3	5	50.0	66.7
0100_000	Reserved										

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)^{1,2} (continued)

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
0100_001	50.0	66.7	6	300.0	400.0	6	300.0	400.0	6	50.0	66.7
0100_010	50.0	66.7	6	300.0	400.0	7	350.0	466.6	6	50.0	66.7
0100_011	50.0	66.7	6	300.0	400.0	8	400.0	533.3	6	50.0	66.7
0101_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0101_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0101_010	50.0	66.7	2	100.0	133.3	3.5	175.0	233.3	2	50.0	66.7
0101_011	50.0	66.7	2	100.0	133.3	4	200.0	266.6	2	50.0	66.7
0101_100	50.0	66.7	2	100.0	133.3	4.5	225.0	300.0	2	50.0	66.7
0101_101	83.3	111.1	3	250.0	333.3	3.5	291.7	388.9	5	50.0	66.7
0101_110	83.3	111.1	3	250.0	333.3	4	333.3	444.4	5	50.0	66.7
0101_111	83.3	111.1	3	250.0	333.3	4.5	375.0	500.0	5	50.0	66.7
0110_000	60.0	80.0	2.5	150.0	200.0	2.5	150.0	200.0	3	50.0	66.7
0110_001	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0110_010	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7
0110_011	60.0	80.0	2.5	150.0	200.0	4	240.0	320.0	3	50.0	66.7
0110_100	60.0	80.0	2.5	150.0	200.0	4.5	270.0	360.0	3	50.0	66.7
0110_101	60.0	80.0	2.5	150.0	200.0	5	300.0	400.0	3	50.0	66.7
0110_110	60.0	80.0	2.5	150.0	200.0	6	360.0	480.0	3	50.0	66.7
0111_000	Reserved										
0111_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0111_010	50.0	66.7	3	150.0	200.0	3.5	175.0	233.3	3	50.0	66.7
0111_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0111_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7
1000_000	Reserved										
1000_001	66.7	88.9	3	200.0	266.6	3	200.0	266.6	4	50.0	66.7

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)^{1,2} (continued)

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
1011_100	80.0	106.7	2.5	200.0	266.6	4	320.0	426.6	4	50.0	66.7
1011_101	80.0	106.7	2.5	200.0	266.6	4.5	360.0	480.0	4	50.0	66.7
1101_000	100.0	133.3	2.5	250.0	333.3	3	300.0	400.0	5	50.0	66.7
1101_001	100.0	133.3	2.5	250.0	333.3	3.5	350.0	466.6	5	50.0	66.7
1101_010	100.0	133.3	2.5	250.0	333.3	4	400.0	533.3	5	50.0	66.7
1101_011	100.0	133.3	2.5	250.0	333.3	4.5	450.0	599.9	5	50.0	66.7
1101_100	100.0	133.3	2.5	250.0	333.3	5	500.0	666.6	5	50.0	66.7
1101_101	125.0	166.7	2	250.0	333.3	3	375.0	500.0	5	50.0	66.7
1101_110	125.0	166.7	2	250.0	333.3	4	500.0	666.6	5	50.0	66.7
1110_000	100.0	133.3	3	300.0	400.0	3.5	350.0	466.6	6	50.0	66.7
1110_001	100.0	133.3	3	300.0	400.0	4	400.0	533.3	6	50.0	66.7
1110_010	100.0	133.3	3	300.0	400.0	4.5	450.0	599.9	6	50.0	66.7
1110_011	100.0	133.3	3	300.0	400.0	5	500.0	666.6	6	50.0	66.7
1110_100	100.0	133.3	3	300.0	400.0	5.5	550.0	733.3	6	50.0	66.7
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

¹ The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

² PCI_MODCK determines the PCI clock frequency range. See [Table 18](#) for lower range configurations.

³ MODCK_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

⁴ CPM multiplication factor = CPM clock/bus clock

⁵ CPU multiplication factor = Core PLL multiplication factor

⁶ CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 0, the ratio of CPM_CLK/PCI_CLK should be calculated from SCCR[PCIDF] as follows:

$$\text{CPM_CLK/PCI_CLK} = (\text{PCIDF} + 1) / 2.$$

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H-MODCK[1-3]											
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1010_101	100.0	200.0	2	200.0	400.0	2.5	250.0	500.0	8	25.0	50.0
1010_110	100.0	200.0	2	200.0	400.0	3	300.0	600.0	8	25.0	50.0
1010_111	100.0	200.0	2	200.0	400.0	3.5	350.0	700.0	8	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0

Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)^{1,2} (continued)

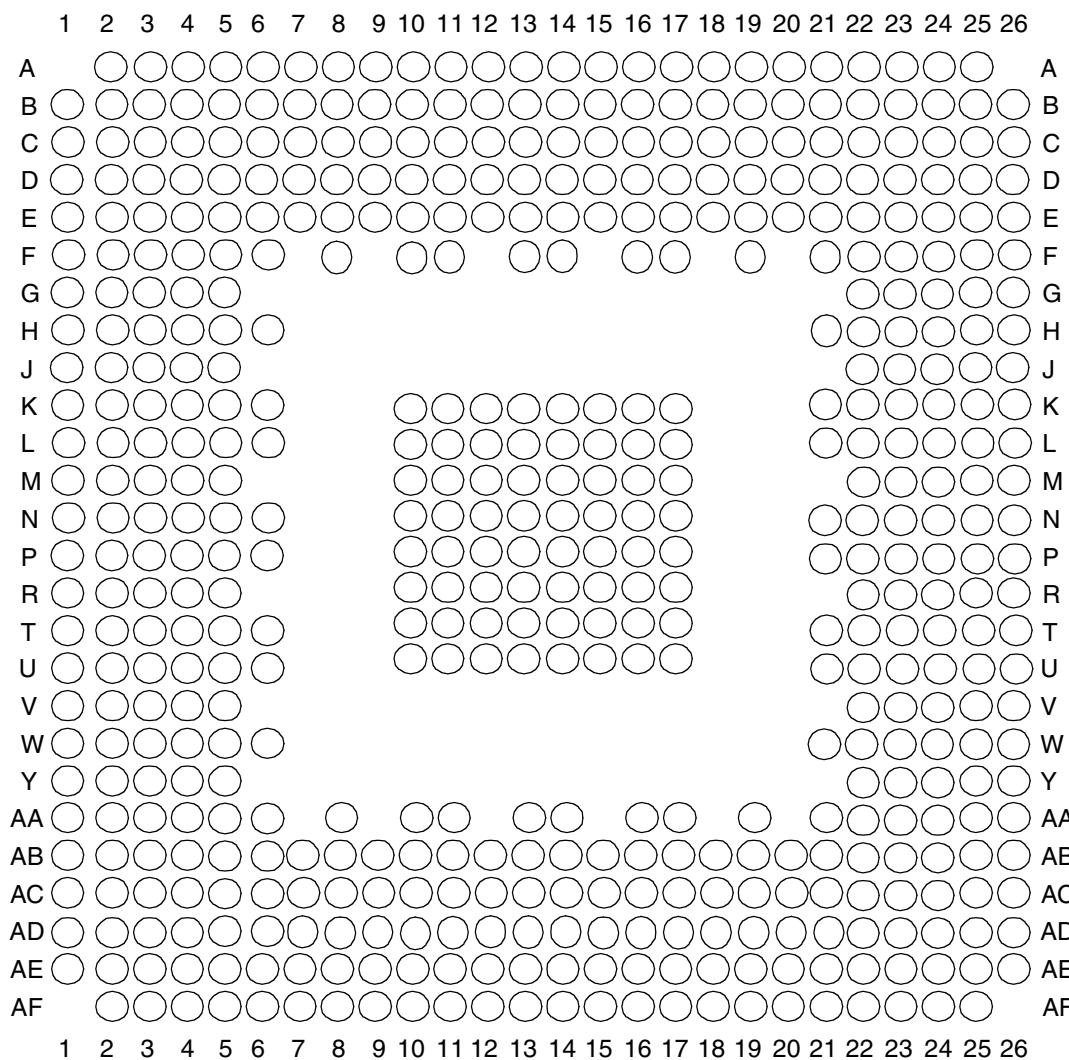
Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)				
	Low	High		Low	High		Low	High		Low	High			
MODCK_H- MODCK[1-3]														
1000_000 Reserved														
1000_001	50.0	66.7	3	150.0	200.0	2.5	150.0	166.7	2.5	60.0	80.0			
1000_010	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0			
1000_011	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0			
1000_100	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0			
1000_101	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0			
1001_000 Reserved														
1001_001	Reserved													
1001_010	Reserved													
1001_011	50.0	66.7	4	200.0	266.6	4	200.0	266.6	4	50.0	66.7			
1001_100	50.0	66.7	4	200.0	266.6	4.5	225.0	300.0	4	50.0	66.7			
1010_000 Reserved														
1010_001	50.0	66.7	4	200.0	266.6	3	200.0	266.6	3	66.7	88.9			
1010_010	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9			
1010_011	50.0	66.7	4	200.0	266.6	4	266.7	355.5	3	66.7	88.9			
1010_100	50.0	66.7	4	200.0	266.6	4.5	300.0	400.0	3	66.7	88.9			
1011_000 Reserved														
1011_001	50.0	66.7	4	200.0	266.6	2.5	200.0	266.6	2.5	80.0	106.7			
1011_010	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7			
1011_011	50.0	66.7	4	200.0	266.6	3.5	280.0	373.3	2.5	80.0	106.7			
1011_100	50.0	66.7	4	200.0	266.6	4	320.0	426.6	2.5	80.0	106.7			
1011_101	50.0	66.7	4	200.0	266.6	2.5	250.0	333.3	2	100.0	133.3			
1011_110	50.0	66.7	4	200.0	266.6	3	300.0	400.0	2	100.0	133.3			
1011_111	50.0	66.7	4	200.0	266.6	3.5	350.0	466.6	2	100.0	133.3			

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H-MODCK[1-3]											
0100_100	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
0101_000	30.0	50.0	5	150.0	250.0	2.5	150.0	250.0	2.5	60.0	100.0
0101_001	25.0	50.0	5	125.0	250.0	3	150.0	300.0	2.5	50.0	100.0
0101_010	25.0	50.0	5	125.0	250.0	3.5	175.0	350.0	2.5	50.0	100.0
0101_011	25.0	50.0	5	125.0	250.0	4	200.0	400.0	2.5	50.0	100.0
0101_100	25.0	50.0	5	125.0	250.0	4.5	225.0	450.0	2.5	50.0	100.0
0101_101	25.0	50.0	5	125.0	250.0	5	250.0	500.0	2.5	50.0	100.0
0101_110	25.0	50.0	5	125.0	250.0	5.5	275.0	550.0	2.5	50.0	100.0
0110_000	Reserved										
0110_001	25.0	50.0	8	200.0	400.0	3	200.0	400.0	3	66.7	133.3
0110_010	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
0110_011	25.0	50.0	8	200.0	400.0	4	266.7	533.3	3	66.7	133.3
0110_100	25.0	50.0	8	200.0	400.0	4.5	300.0	600.0	3	66.7	133.3
0111_000	25.0	50.0	6	150.0	300.0	2	150.0	300.0	2	75.0	150.0
0111_001	25.0	50.0	6	150.0	300.0	2.5	187.5	375.0	2	75.0	150.0
0111_010	25.0	50.0	6	150.0	300.0	3	225.0	450.0	2	75.0	150.0
0111_011	25.0	50.0	6	150.0	300.0	3.5	262.5	525.0	2	75.0	150.0
1000_000	Reserved										
1000_001	25.0	50.0	6	150.0	300.0	2.5	150.0	300.0	2.5	60.0	120.0
1000_010	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
1000_011	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
1000_100	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
1000_101	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
1001_000	Reserved										
1001_001	Reserved										

Pinout

This figure shows the pinout of the 516 PBGA package as viewed from the top surface.



Not to Scale

Figure 12. Pinout of the 516 PBGA Package (View from Top)

This table lists the pins of the MPC8272. Note that the pins in the “MPC8272/8271 Only” column relate to Utopia functionality.

Table 21. Pinout

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
BR		A19
BG/IRQ6		D2
ABB/IRQ2		C1

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
D46		H4
D47		F2
D48		AB1
D49		U4
D50		U1
D51		R3
D52		N3
D53		K2
D54		H5
D55		F4
D56		AA3
D57		U5
D58		U2
D59		P5
D60		M3
D61		K4
D62		H3
D63		E1
IRQ3/CKSTP_OUT/EXT_BR3		B16
IRQ4/CORE_SRESET/EXT_BG3		C15
IRQ5/TBEN/EXT_DBG3/CINT		Y4
PSDVAL		C19
TA		AA4
TEA		AB6
GBL/IRQ1		D15
CI/BADDR29/IRQ2		D16
WT/BADDR30/IRQ3		C16
BADDR31/IRQ5/CINT		E17
CPU_BR/INT_OUT		B20
CS0		AE6
CS1		AD7

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PCI_IRDY		AF15
PCI_STOP		AE15
PCI_DEVSEL		AE14
PCI_IDSEL		AC17
PCI_PERR		AD14
PCI_SERR		AD13
PCI_REQ0		AE20
PCI_REQ1/CPCI_HS_ES		AF14
PCI_GNT0		AD20
PCI_GNT1/CPCI_HS_LED		AE13
PCI_GNT2/CPCI_HS_ENUM		AF21
PCI_RST		AF22
PCI_INTA		AE21
PCI_REQ2		AB14
DLLOUT		AC22
PCI_AD0		AF7
PCI_AD1		AE10
PCI_AD2		AB10
PCI_AD3		AD10
PCI_AD4		AE9
PCI_AD5		AF8
PCI_AD6		AC10
PCI_AD7		AE11
PCI_AD8		AB11
PCI_AD9		AF10
PCI_AD10		AF9
PCI_AD11		AB12
PCI_AD12		AC12
PCI_AD13		AD12
PCI_AD14		AF11
PCI_AD15		AB13

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PCI_AD16		AE16
PCI_AD17		AF17
PCI_AD18		AD16
PCI_AD19		AC16
PCI_AD20		AF18
PCI_AD21		AB16
PCI_AD22		AD17
PCI_AD23		AF19
PCI_AD24		AB17
PCI_AD25		AF20
PCI_AD26		AE19
PCI_AD27		AC18
PCI_AD28		AB18
PCI_AD29		AD19
PCI_AD30		AD21
PCI_AD31		AC20
<u>PCI_C0/BE0</u>		AE12
<u>PCI_C1/BE1</u>		AF13
<u>PCI_C2/BE2</u>		AC15
<u>PCI_C3/BE3</u>		AE18
<u>IRQ0/NMI_OUT</u>		A17
<u>TRST²</u>		E21
TCK		B22
TMS		C23
TDI		B24
TDO		A22
<u>TRIS</u>		B23
<u>PORESET²/PCI_RST</u>		C24
<u>HRESET</u>		D22
<u>SRESET</u>		F22
<u>RSTCONF</u>		A24

9 Package Description

This figure shows the side profile of the PBGA package to indicate the direction of the top surface view.

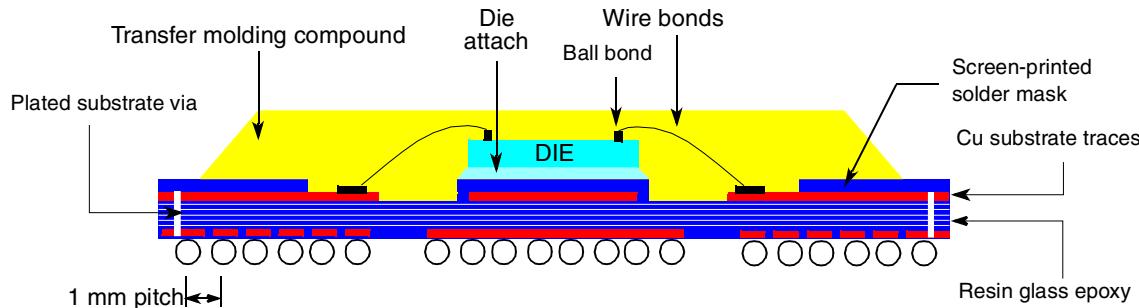


Figure 13. Side View of the PBGA Package Remove

9.1 Package Parameters

This table provides package parameters.

Table 22. Package Parameters

Code	Type	Outline (mm)	Interconnects	Pitch (mm)	Nominal Unmounted Height (mm)
VR, ZQ	PBGA	27 x 27	516	1	2.25

NOTE: Temperature Reflow for the VR Package

In the VR package, sphere composition is lead-free (see [Table 2](#)). This requires higher temperature reflow than what is required for other PowerQUICC II packages. Consult “Freescale PowerQUICC II Pb-Free Packaging Information” (MPC8250PBFREEPKG) available on www.freescale.com.